



Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of “Quality Parts,Customers Priority,Honest Operation,and Considerate Service”,our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

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(NPN) MPSA05, MPSA06*, (PNP) MPSA55, MPSA56*

*Preferred Devices

Amplifier Transistors

Voltage and Current are Negative
for PNP Transistors

Features

- Pb-Free Packages are Available*

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Collector–Emitter Voltage MPSA05, MPSA55 MPSA06, MPSA56	V_{CEO}	60 80	Vdc
Collector–Base Voltage MPSA05, MPSA55 MPSA06, MPSA56	V_{CBO}	60 80	Vdc
Emitter–Base Voltage	V_{EBO}	4.0	Vdc
Collector Current – Continuous	I_C	500	mAdc
Total Device Dissipation @ $T_A = 25^\circ\text{C}$ Derate above 25°C	P_D	625 5.0	W mW/ $^\circ\text{C}$
Total Device Dissipation @ $T_C = 25^\circ\text{C}$ Derate above 25°C	P_D	1.5 12	W mW/ $^\circ\text{C}$
Operating and Storage Junction Temperature Range	T_J, T_{stg}	-55 to +150	$^\circ\text{C}$

THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction-to-Ambient (Note 1)	$R_{\theta JA}$	200	$^\circ\text{C}/\text{W}$
Thermal Resistance, Junction-to-Case	$R_{\theta JC}$	83.3	$^\circ\text{C}/\text{W}$

Maximum ratings are those values beyond which device damage can occur. Maximum ratings applied to the device are individual stress limit values (not normal operating conditions) and are not valid simultaneously. If these limits are exceeded, device functional operation is not implied, damage may occur and reliability may be affected.

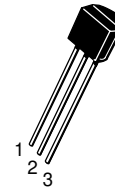
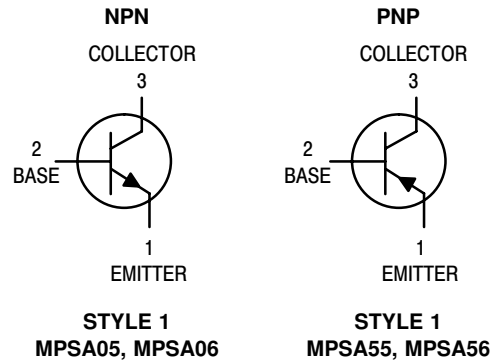
1. $R_{\theta JA}$ is measured with the device soldered into a typical printed circuit board.

*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.



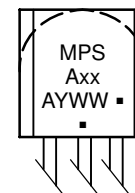
ON Semiconductor®

<http://onsemi.com>



TO-92
CASE 29-11
STYLE 1

MARKING DIAGRAM



MPSAxx = Device Code
xx = 05, 06, 55 or 56

A = Assembly Location

Y = Year

WW = Work Week

▪ = Pb-Free Package

(Note: Microdot may be in either location)

ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 6 of this data sheet.

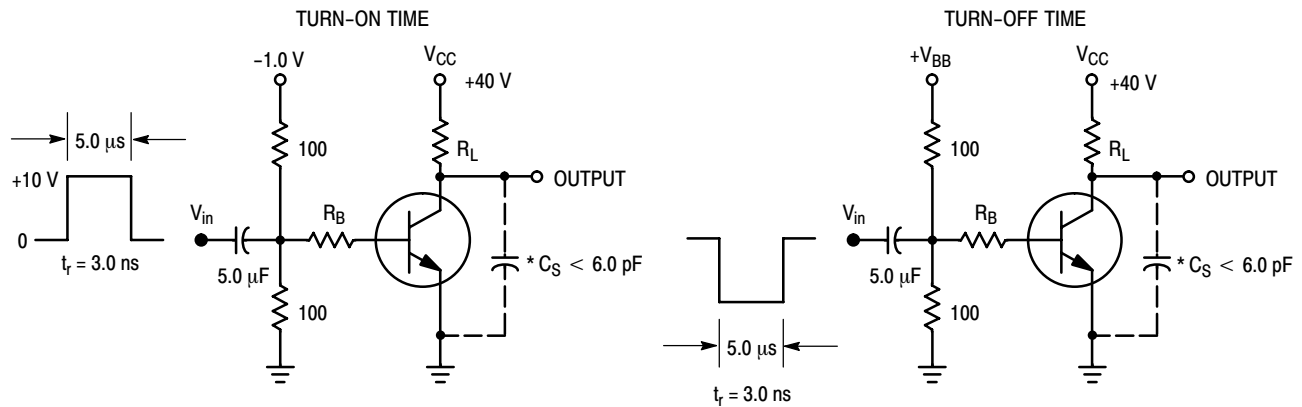
Preferred devices are recommended choices for future use and best overall value.

(NPN) MPSA05, MPSA06*, (PNP) MPSA55, MPSA56*

ELECTRICAL CHARACTERISTICS ($T_A = 25^\circ\text{C}$ unless otherwise noted)

Characteristic	Symbol	Min	Max	Unit
OFF CHARACTERISTICS				
Collector–Emitter Breakdown Voltage (Note 2) ($I_C = 1.0\text{ mAdc}$, $I_B = 0$)	$V_{(BR)CEO}$	60 80	– –	Vdc
Emitter–Base Breakdown Voltage ($I_E = 100\ \mu\text{Adc}$, $I_C = 0$)	$V_{(BR)EBO}$	4.0	–	Vdc
Collector Cutoff Current ($V_{CE} = 60\text{ Vdc}$, $I_B = 0$)	I_{CES}	–	0.1	μAdc
Collector Cutoff Current ($V_{CB} = 60\text{ Vdc}$, $I_E = 0$) ($V_{CB} = 80\text{ Vdc}$, $I_E = 0$)	I_{CBO}	– –	0.1 0.1	μAdc
ON CHARACTERISTICS				
DC Current Gain ($I_C = 10\text{ mAdc}$, $V_{CE} = 1.0\text{ Vdc}$) ($I_C = 100\text{ mAdc}$, $V_{CE} = 1.0\text{ Vdc}$)	h_{FE}	100 100	– –	–
Collector–Emitter Saturation Voltage ($I_C = 100\text{ mAdc}$, $I_B = 10\text{ mAdc}$)	$V_{CE(sat)}$	–	0.25	Vdc
Base–Emitter On Voltage ($I_C = 100\text{ mAdc}$, $V_{CE} = 1.0\text{ Vdc}$)	$V_{BE(on)}$	–	1.2	Vdc
SMALL–SIGNAL CHARACTERISTICS				
Current–Gain – Bandwidth Product (Note 3) ($I_C = 10\text{ mA}$, $V_{CE} = 2.0\text{ V}$, $f = 100\text{ MHz}$) ($I_C = 100\text{ mAdc}$, $V_{CE} = 1.0\text{ Vdc}$, $f = 100\text{ MHz}$)	f_T	100 50	– –	MHz

- Pulse Test: Pulse Width $\leq 300\ \mu\text{s}$, Duty Cycle $\leq 2\%$.
- f_T is defined as the frequency at which $|h_{fe}|$ extrapolates to unity.



*Total Shunt Capacitance of Test Jig and Connectors For PNP Test Circuits, Reverse All Voltage Polarities

Figure 1. Switching Time Test Circuits

(NPN) MPSA05, MPSA06*, (PNP) MPSA55, MPSA56*

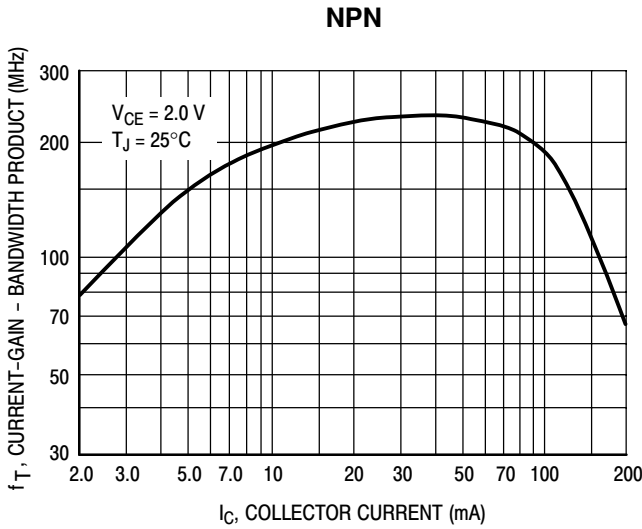


Figure 2. MPSA05/06 Current-Gain — Bandwidth Product

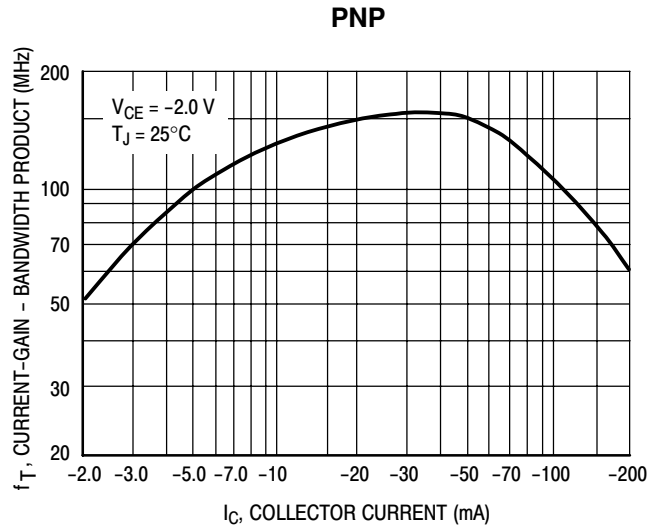


Figure 3. MPSA55/56 Current-Gain — Bandwidth Product

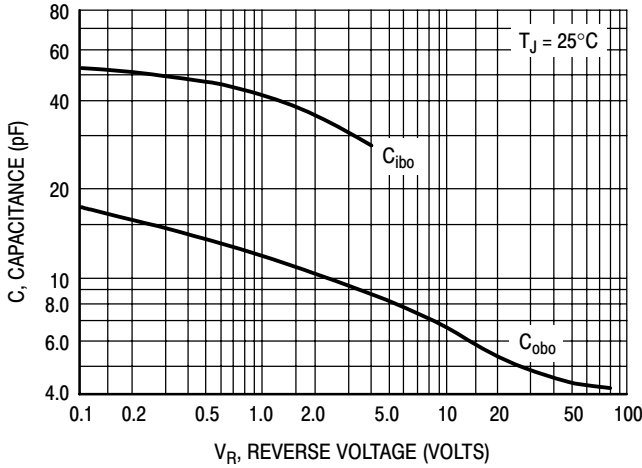


Figure 4. MPSA05/06 Capacitance

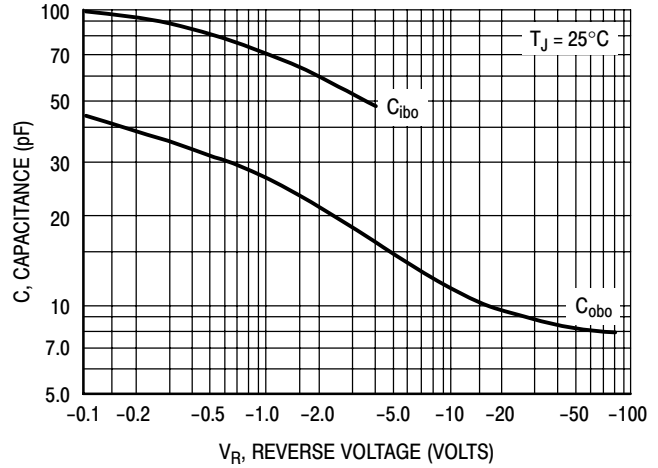


Figure 5. MPSA55/56 Capacitance

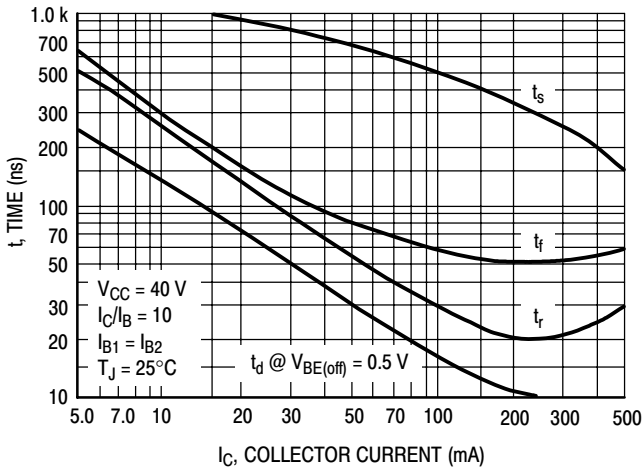


Figure 6. MPSA05/06 Switching Time

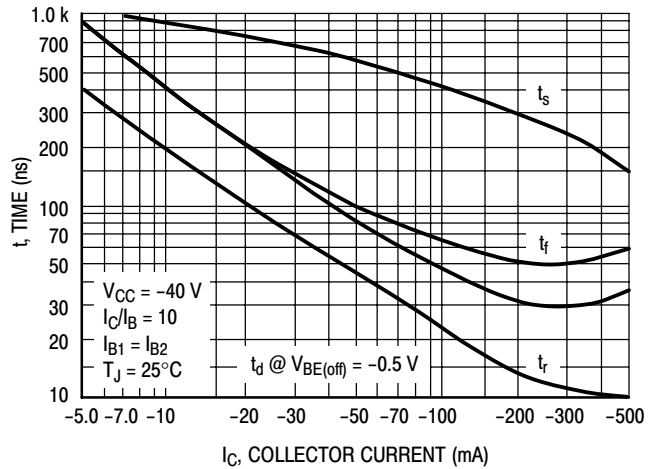


Figure 7. MPSA55/56 Switching Time

(NPN) MPSA05, MPSA06*, (PNP) MPSA55, MPSA56*

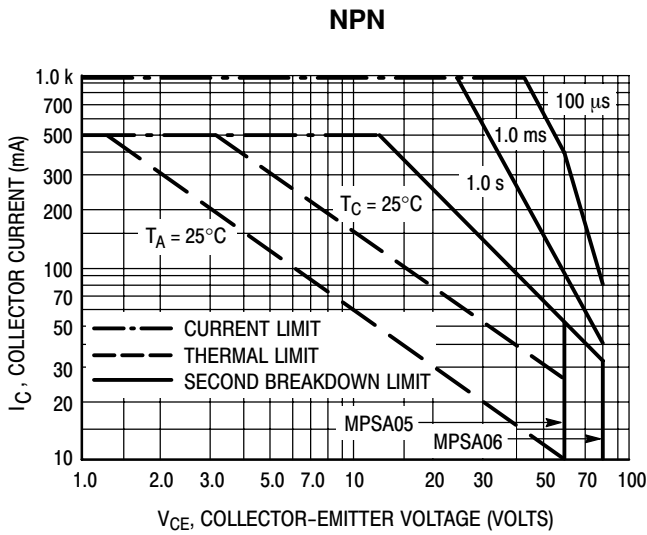


Figure 8. MPSA05/06 Active-Region Safe Operating Area

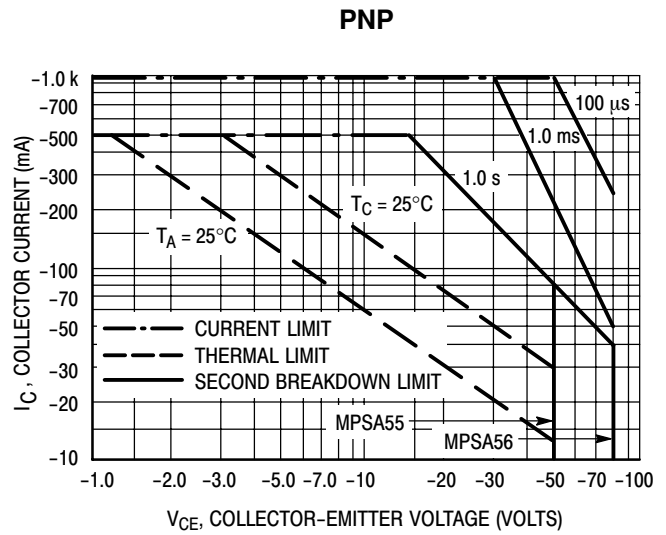


Figure 9. MPSA55/56 Active-Region Safe Operating Area

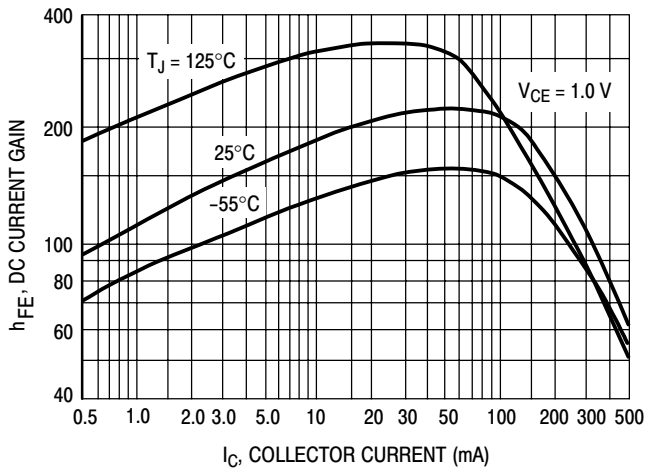


Figure 10. MPSA05/06 DC Current Gain

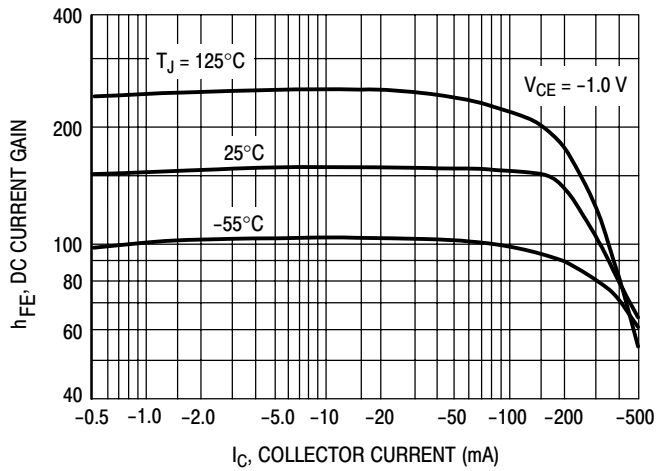


Figure 11. MPSA55/56 DC Current Gain

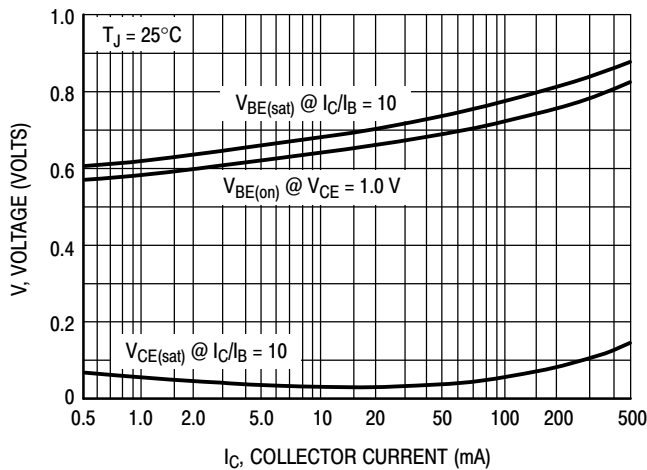


Figure 12. MPSA05/06 "ON" Voltages

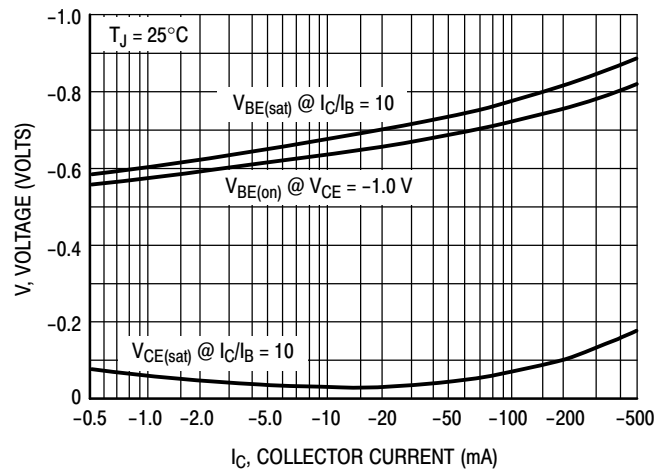


Figure 13. MPSA55/56 "ON" Voltages

(NPN) MPSA05, MPSA06*, (PNP) MPSA55, MPSA56*

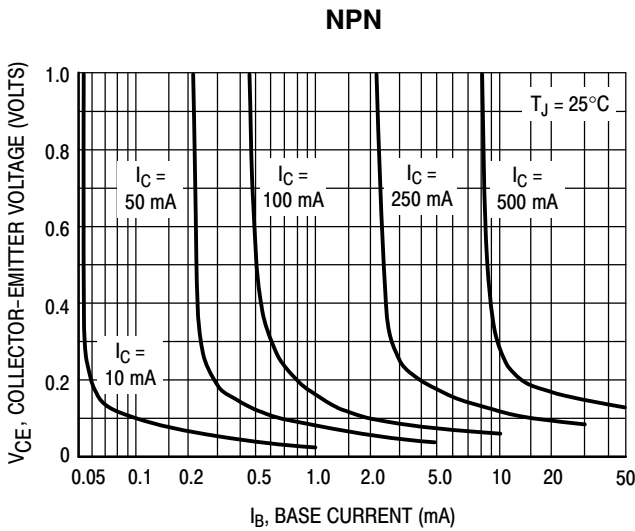


Figure 14. MPSA05/06 Collector Saturation Region

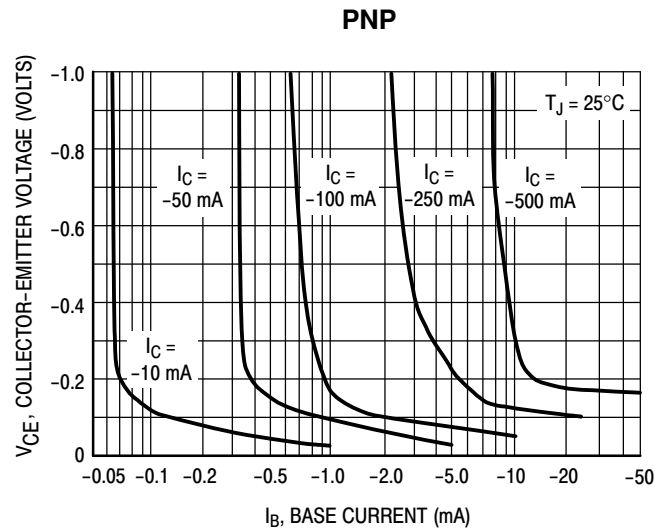


Figure 15. MPSA55/56 Collector Saturation Region

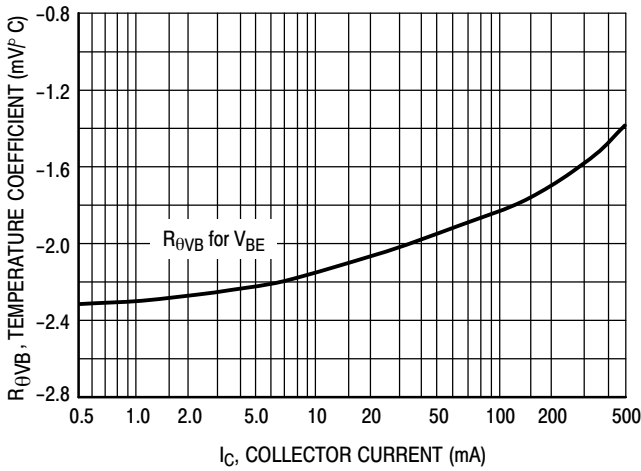


Figure 16. MPSA05/06 Base-Emitter Temperature Coefficient

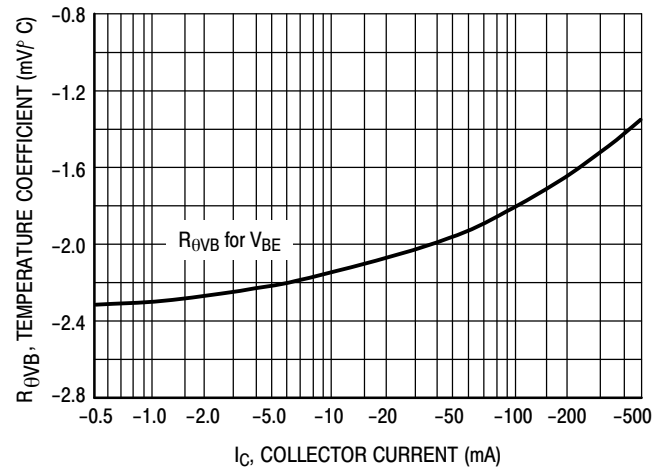


Figure 17. MPSA55/56 Base-Emitter Temperature Coefficient

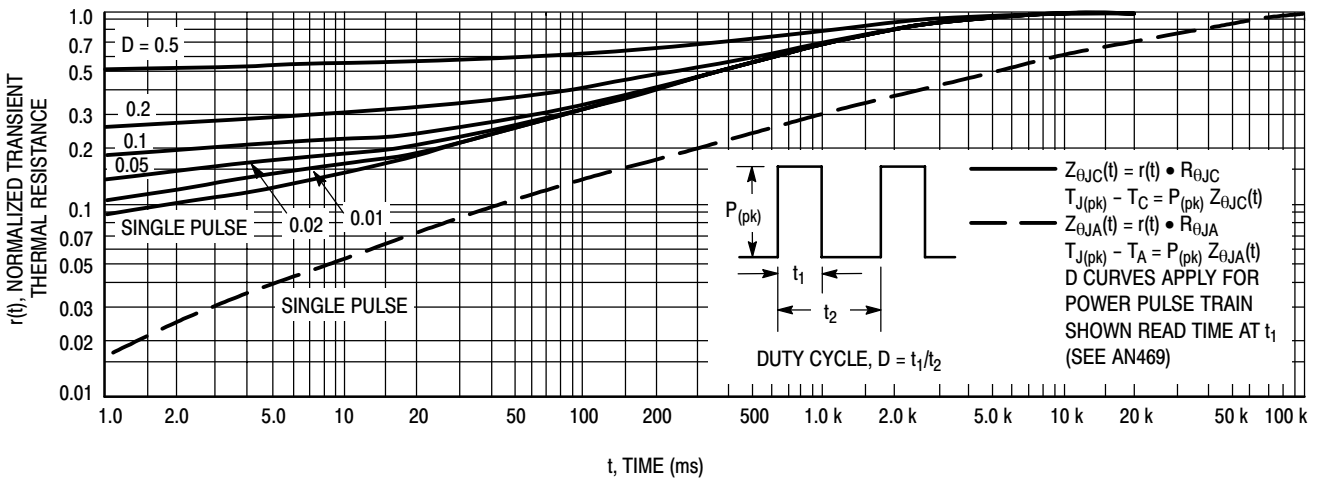


Figure 18. MPSA05, MPSA06, MPSA55 and MPSA56 Thermal Response

(NPN) MPSA05, MPSA06*, (PNP) MPSA55, MPSA56*

ORDERING INFORMATION

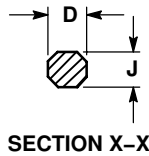
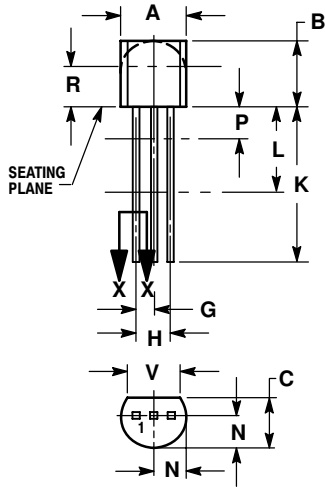
Device	Package	Shipping†
MPSA05	TO-92	5,000 Units / Box
MPSA05G	TO-92 (Pb-Free)	5,000 Units / Box
MPSA05RLRA	TO-92	2,000 / Tape & Reel
MPSA05RLRAG	TO-92 (Pb-Free)	2,000 / Tape & Reel
MPSA05RLRM	TO-92	2,000 / Ammo Pack
MPSA05RLRMG	TO-92 (Pb-Free)	2,000 / Ammo Pack
MPSA06	TO-92	5,000 Units / Box
MPSA06G	TO-92 (Pb-Free)	5,000 Units / Box
MPSA06RL1	TO-92	2,000 / Tape & Reel
MPSA06RL1G	TO-92 (Pb-Free)	2,000 / Tape & Reel
MPSA06RL	TO-92	2,000 / Tape & Reel
MPSA06RLG	TO-92 (Pb-Free)	2,000 / Tape & Reel
MPSA06RLRA	TO-92	2,000 / Tape & Reel
MPSA06RLRAG	TO-92 (Pb-Free)	2,000 / Tape & Reel
MPSA06RLRM	TO-92	2,000 / Ammo Pack
MPSA06RLRMG	TO-92 (Pb-Free)	2,000 / Ammo Pack
MPSA06RLRP	TO-92	2,000 / Ammo Pack
MPSA06RLRPG	TO-92 (Pb-Free)	2,000/Ammo Pack
MPSA55	TO-92	5,000 Units / Box
MPSA55G	TO-92 (Pb-Free)	5,000 Units / Box
MPSA55RLRA	TO-92	2,000 / Tape & Reel
MPSA55RLRAG	TO-92 (Pb-Free)	2,000 / Tape & Reel
MPSA56	TO-92	5,000 Units / Box
MPSA56G	TO-92 (Pb-Free)	5,000 Units / Box
MPSA56RLRA	TO-92	2,000 / Tape & Reel
MPSA56RLRAG	TO-92 (Pb-Free)	2,000 / Tape & Reel
MPSA56RLRM	TO-92	2,000 / Ammo Pack
MPSA56RLRMG	TO-92 (Pb-Free)	2,000 / Ammo Pack
MPSA56RLRP	TO-92	2,000 / Ammo Pack
MPSA56RLRPG	TO-92 (Pb-Free)	2,000 / Ammo Pack
MPSA56ZL1	TO-92	2,000 / Ammo Pack
MPSA56ZL1G	TO-92 (Pb-Free)	2,000 / Ammo Pack

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

(NPN) MPSA05, MPSA06*, (PNP) MPSA55, MPSA56*

PACKAGE DIMENSIONS

TO-92 (TO-226)
CASE 29-11
ISSUE AL



NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.
3. CONTOUR OF PACKAGE BEYOND DIMENSION R IS UNCONTROLLED.
4. LEAD DIMENSION IS UNCONTROLLED IN P AND BEYOND DIMENSION K MINIMUM.

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.175	0.205	4.45	5.20
B	0.170	0.210	4.32	5.33
C	0.125	0.165	3.18	4.19
D	0.016	0.021	0.407	0.533
G	0.045	0.055	1.15	1.39
H	0.095	0.105	2.42	2.66
J	0.015	0.020	0.39	0.50
K	0.500	---	12.70	---
L	0.250	---	6.35	---
N	0.080	0.105	2.04	2.66
P	---	0.100	---	2.54
R	0.115	---	2.93	---
V	0.135	---	3.43	---

STYLE 1:

1. PIN 1. EMITTER
2. BASE
3. COLLECTOR

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